

< High-power GaAs FET (small signal gain stage) >

MGF0904A

L & S BAND / 0.6W non - matched

DESCRIPTION

The MGF0904A, GaAs FET with an N-channel schottky gate, is designed for use in UHF band amplifiers.

FEATURES

- High output power
- Po=28.0dBm(TYP.) @f=1.65GHz,Pin=15dBm • High power gain
 - Gp=13.0dB(TYP.) @f=1.65GHz,Pin=15dBm
- High power added efficiency P.A.E =40%(TYP.) @f=1.65GHz,Pin=15dBm

APPLICATION

• For UHF Band power amplifiers

QUALITY

• GG

RECOMMENDED BIAS CONDITIONS

• Vds=8V • Ids=200mA • Rg=500Ω Refer to Bias Procedure

Absolute maximum ratings (Ta=25°C) Symbol Parameter Ratings Unit VGDO Gate to drain voltage -17 V Gate to source voltage -17 V VGSO 800 ID Drain current mΑ -2.5 IGR mΑ Reverse gate current IGF 5.4 mΑ Forward gate current 3.75 W PT*1 Total power dissipation Tch 175 °C Cannel temperature -65 to +175 °C Tstg Storage temperature

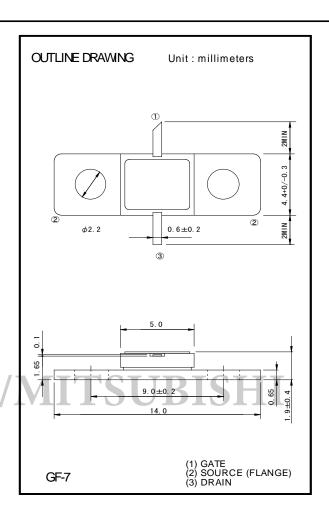


Electrical characteristics (Ta=25°C)

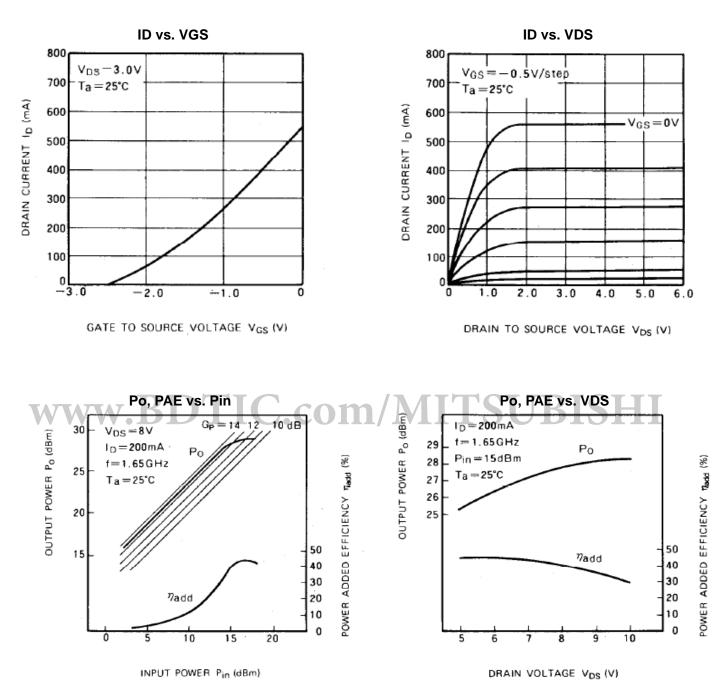
Symbol	Parameter	Test conditions		Limits			
			Min.	Тур.	Max.		
IDSS	Saturated drain current	VDS=3V,VGS=0V	400	550	800	mA	
gm	Transconductance	VDS=3V,ID=300mA	120	200	-	mS	
VGS(off)	Gate to source cut-off voltage	VDS=3V,ID=2.5mA	-1	-3	-5	V	
Po	Output power VDS=8V,ID(RF off)=200mA		26	28	-	dBm	
P.A.E.	Power added efficiency	f=1.65GHz,Pin=15dBm	-	40	-	%	
Rth(ch-c) *2	Thermal resistance	∆ Vf method	-	-	40	°C/W	
Rth(ch-a) *3	Thermal resistance	∆ Vf method	-	-	100	°C/W	

*2 :Channel-case

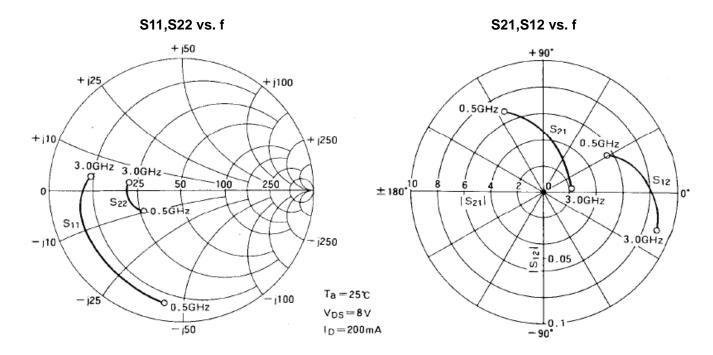
*3 :Channel-ambient



MGF0904A TYPICAL CHARACTERISTICS (Ta=25deg.C)



MGF0904A S-parameters(Ta=25deg.C, VDS=8(V),IDS=200(mA))



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f	S Parameters(Typ.)										
(GHz)	S11		S21		S12		S22		К	MSG/MAG	
	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)	Magn.	Angle(deg.)	-	dB	
0.5	0.851	-99.0	6.855	116.0	0.055	31.0	0.338	-149.0	0.277	21.0	
1.0	0.801	-138.0	4.265	89.0	0.064	22.5	0.368	-162.0	0.521	18.2	
1.5	0.788	-161.5	3.192	71.0	0.072	13.0	0.390	-173.3	0.655	16.5	
2.0	0.740	-177.0	2.544	52.0	0.079	4.0	0.409	-178.0	0.847	15.1	
2.5	0.713	176.5	2.180	30.0	0.085	-7.0	0.411	177.0	0.940	14.1	
3.0	0.670	171.5	2.040	9.0	0.091	-18.0	0.402	172.0	1.070	11.9	

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